

101125

AT-0017A

VHF TRANSISTOR



TRANSISTOR DATA SHEET

Silicon Planar UHF Transistor NPN Epitaxial



FEATURES

- Very Low Noise Figure
- Wide Dynamic Range
- High Power Gain

DESCRIPTION

AT-0017A transistors are designed primarily for small ultra-low noise amplifier applications. Their exceptional noise figure versus collector current characteristics make them ideally suited for applications where high dynamic range is required.

COMMON EMITTER OPERATING CHARACTERISTICS (T_A = 25° C)

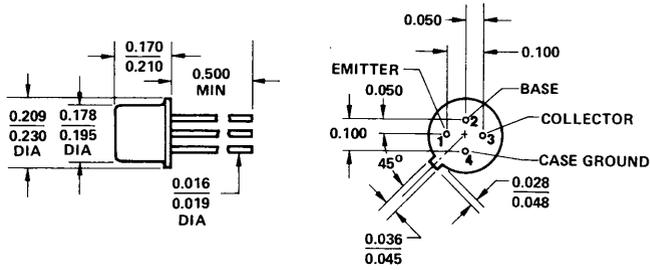
Parameters	Symbols	Test Conditions	Min	Typ	Max
Spot Noise Figure	NF	V _{CB} = 10V, I _C = 5 mA, f = 60 MHz			1.2 dB
Power Gain	G _{pe}	V _{CB} = 10V, I _C = 5 mA, f = 60 MHz (see figure 1)		25 dB	

ELECTRICAL CHARACTERISTICS (T_A = 25° C)

Parameters	Symbols	Test Conditions	Min	Typ	Max
Collector-Base Breakdown Voltage	V _{(BR)CBO}	I _E = 0, I _C = 10 μA	20V		
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	I _E = 10 μA, I _C = 0	3V		
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	I _C = 100 μA, I _B = 0	12V		
Collector Cutoff Current	I _{CBO}	V _{CB} = 10V, I _E = 0		10 nA	
Forward Current Transfer Ratio	h _{FE}	V _{CE} = 10V, I _C = 5 mA	20	75	
Current-Gain Transition Frequency	f _T	V _{CB} = 10V, I _C = 15 mA		3.5 GHz	
Collector-Base Capacitance	C _{cb}	V _{CB} = 10V, I _E = 0		0.8 pF	

16.5.75

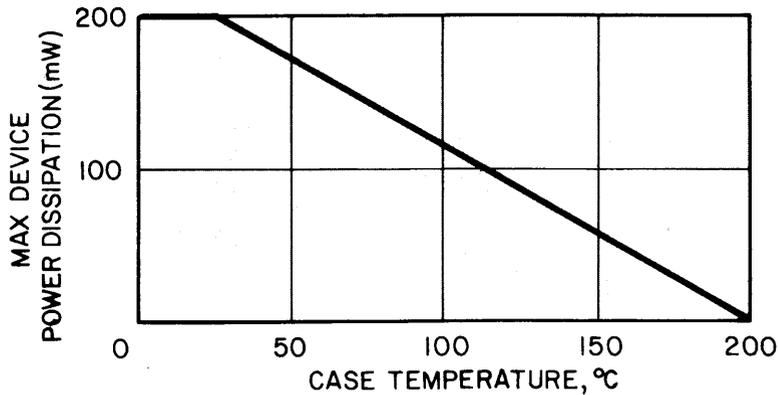
TO-72 PACKAGE



MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

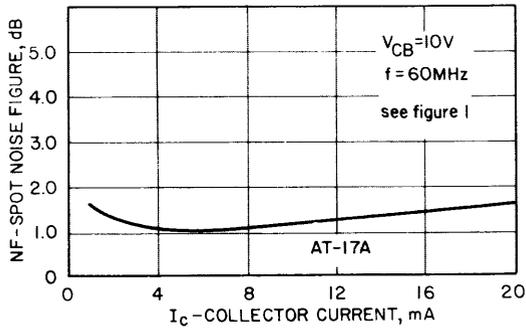
Parameter	Symbol	Limit
Reverse Emitter Base Voltage	V_{EB}	3V
Reverse Collector Base Voltage	V_{CB}	20V
Open Base Collector-Emitter Voltage	V_{CEO}	12V
Collector Current	I_C	100 mA
Continuous Dissipation	P_T	200 mW
Junction Temperature	T_j	200°C
Storage Temperature Range	T_{STG}	-65 to 200°C

POWER DERATING CURVE

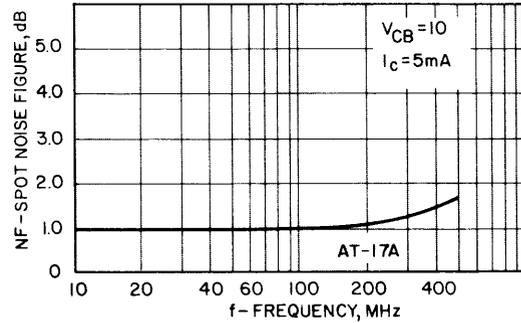


TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

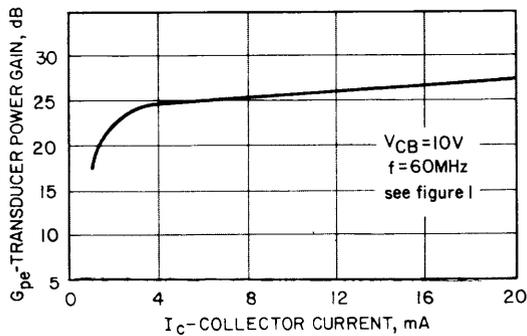
SPOT NOISE FIGURE
VS
COLLECTOR CURRENT



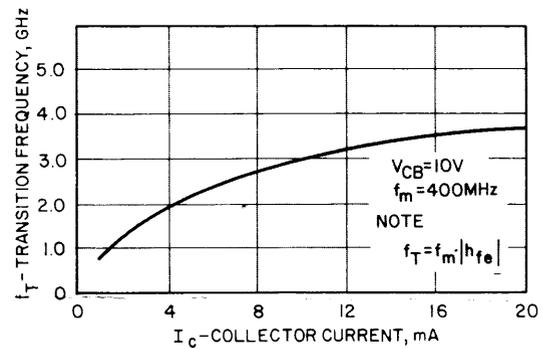
SPOT NOISE FIGURE
VS
FREQUENCY



TRANSDUCER POWER GAIN
VS
COLLECTOR CURRENT



TRANSITION FREQUENCY
VS
COLLECTOR CURRENT



PARAMETER MEASUREMENT INFORMATION

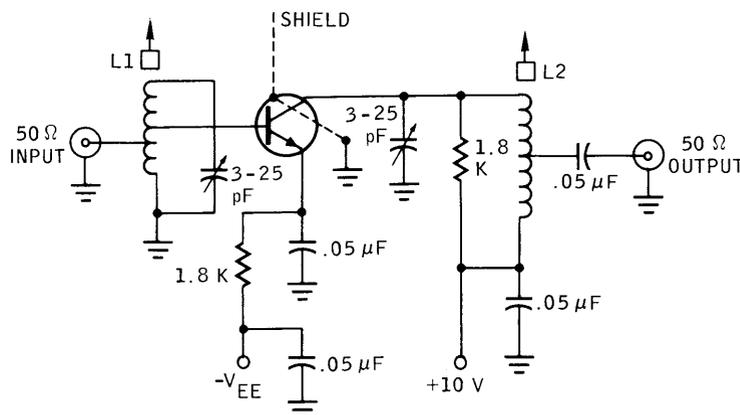


Figure 1 - Power Gain and Noise Figure Test Circuit (60 MHz)

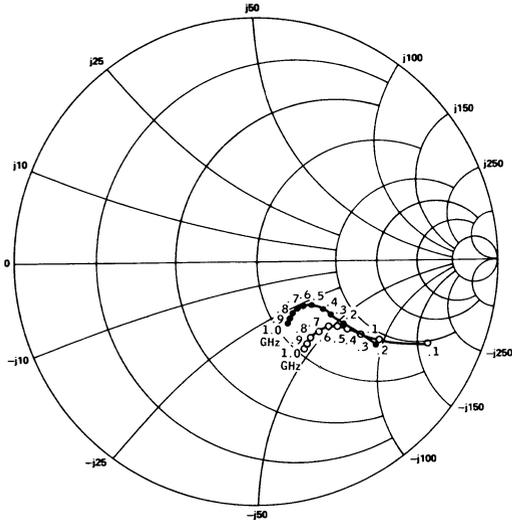
Notes:

L1 and L2 wound on 3/8 in. OD Miller (or equivalent) Ceramic Forms with Blue-Coded Powdered Iron Cores

L1: 0.6 in. Long, 6 Turns #14 Solid Copper Wire; Input Tap @ 2-1/8 Turns, Base Tap @ 2-5/8 Turns

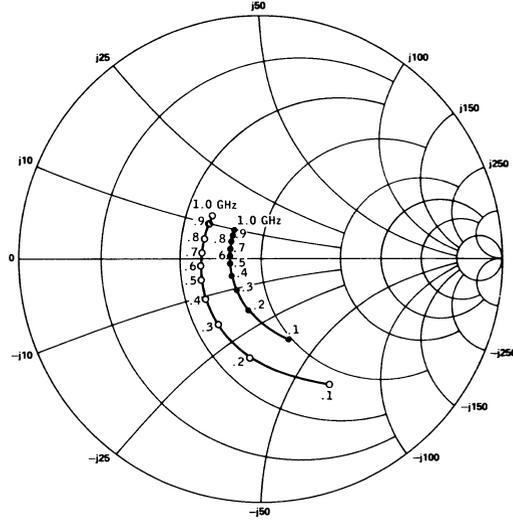
L2: 0.7 in. Long, 7-1/2 Turns #14 Solid Copper Wire; Tapped @ 1-7/8 Turns.

TYPICAL SCATTERING PARAMETERS



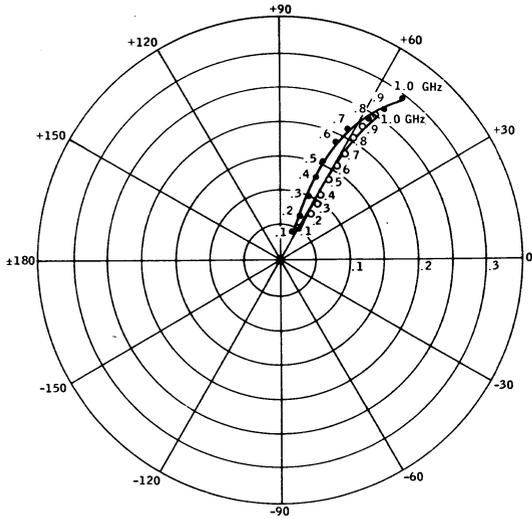
Output Impedance and Output Reflection Coefficient, S_{22e}

$V_{CB} = 10V$ $\circ I_C = 5\text{ mA}$ $\bullet I_C = 15\text{ mA}$



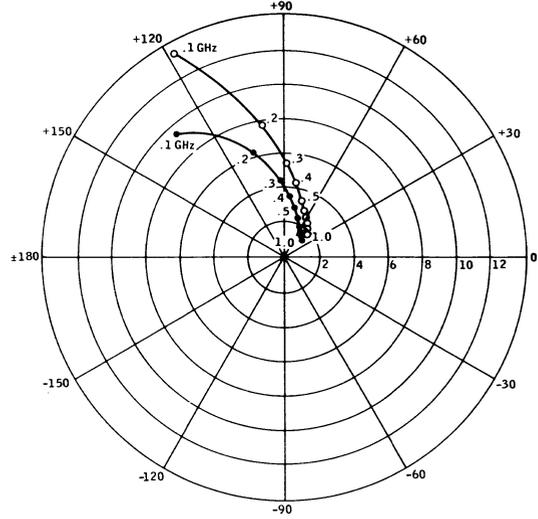
Input Impedance and Input Reflection Coefficient, S_{11e}

$V_{CB} = 10V$ $\circ I_C = 5\text{ mA}$ $\bullet I_C = 15\text{ mA}$



Reverse Transfer Coefficient, S_{12e}

$V_{CB} = 10V$ $\circ I_C = 5\text{ mA}$ $\bullet I_C = 15\text{ mA}$



Forward Transfer Coefficient, S_{21e}

$V_{CB} = 10V$ $\circ I_C = 5\text{ mA}$ $\bullet I_C = 15\text{ mA}$

archive

AVANTEK

AT-0817

VHF TRANSISTOR

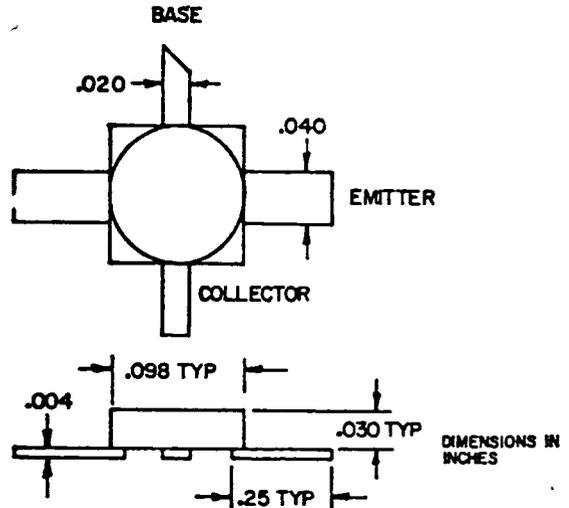
**Silicon Planar
VHF Transistor
NPN Epitaxial**

FEATURES

- Very Low Noise Figure
- Wide Dynamic Range
- High Power Gain

DESCRIPTION

AT-0817 transistors are designed primarily for small-signal, ultra-low-noise amplifier applications in the VHF frequency range.



OPERATING CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

PARAMETERS	SYMBOLS	TEST CONDITIONS	MIN	TYP	MAX
Spot Noise Figure	NF	$V_{CB} = 10\text{V}, I_C = 5\text{ mA}, f = .5\text{ GHz}$			1.7 dB
Power Gain	G_{pe}	$V_{CB} = 10\text{V}, I_C = 5\text{ mA}, f = .5\text{ GHz}$		17 dB	

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Reverse Emitter-Base Voltage	V_{EB}				3V
Reverse Collector-Base Voltage	V_{CB}				20V
Open-Base Collector-Emitter Voltage	V_{CEO}				12V
Collector Current	I_C				100 mA
Continuous Dissipation (see Note)	P_T	$T_A \leq 25^\circ\text{C}$			200 mW
Linear Derating Factor	K_{JA}	$T_A > 25^\circ\text{C}$	1.14 mW/ $^\circ\text{C}$		
Junction Temperature	T_J				200 $^\circ\text{C}$
Storage Temperature	T_{stg}		-65 $^\circ\text{C}$		200 $^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	$I_C = 0, I_E = 10\ \mu\text{A}$	20V		
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	$I_E = 10\ \mu\text{A}, I_C = 0$	3V		
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	$I_C = 100\ \mu\text{A}, I_B = 0$	12V		
Collector Cutoff Current	I_{CBO}	$V_{CB} = 10\text{V}, I_E = 0$		10 nA	
Forward Current Transfer Ratio	h_{FE}	$V_{CE} = 10\text{V}, I_C = 5\text{ mA}$	20	75	
Current-Gain Transition Frequency	f_T	$V_{CB} = 10\text{V}, I_C = 15\text{ mA}$		3.5 GHz	
Collector-Base Capacitance	C_{cb}	$V_{CB} = 10\text{V}, I_E = 0$		0.8 pF	

NOTE: Derate linearly to 200 $^\circ\text{C}$ free-air temperature at the rate of 1.14 mW/ $^\circ\text{C}$.

Avantek

01125



TRANSISTOR DATA SHEET

AT-8110/-8111
2-6 GHz Small Signal
Ultra-Low Noise
Gallium Arsenide FET

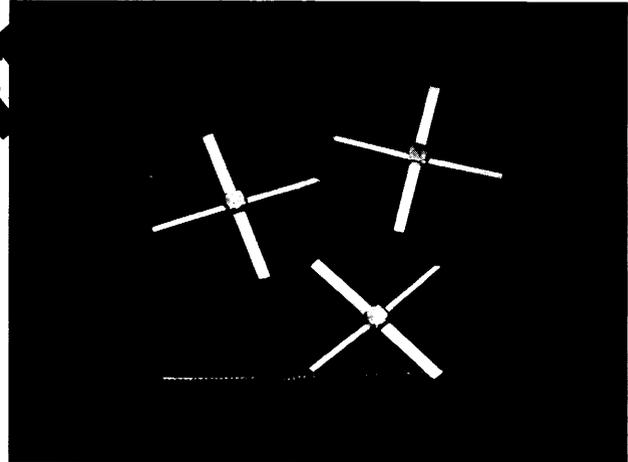
FEATURES

- 1.3 dB NF, 11 dB Gain @ 4 GHz
- 1.7 dB NF, 9 dB Gain @ 6 GHz
- +17 dBm Linear P_O @ 4 GHz
- Excellent 50 ohm Input Match
- All Gold-based Metallization
- Hermetic 70 mil Package or Chip Form
- Very Wide Dynamic Range

TELEMETER ELECTRONIC GMBH

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UPDATE



DESCRIPTION

The AT-8110/-8111 is a gallium arsenide metal-semiconductor field effect transistor with Schottky-barrier gate electrodes, particularly designed for simplified input matching, high gain, low noise figure and wide dynamic range in the 2 to 6 GHz frequency range. It is ideal for narrowband communications and radar amplifiers as well as for wideband EW applications.

This unique GaAs FET combines a half-micron gate length for low noise figure with a 28 gate geometry that provides a close-to-perfect 50 ohm input impedance match and 50 ohm noise match at 4 GHz. This means that the input circuit of a moderate-bandwidth amplifier using the AT-8110/-8111 will normally consist of a single, simple transmission line element. The result is a fast and easy input circuit design and reduced input circuit losses for a significant decrease in overall amplifier noise figure.

In addition to its excellent input characteristics, the AT-8110/-8111 features a 1.3 dB noise figure at 4 GHz with 12 dB associated gain and +17 dBm linear output power capability (at 1 dB gain compression point). The

addition of high power capability to a low noise figure transistor permits an extremely wide dynamic range amplifier front end and excellent amplifier linearity over a wide input signal range. This makes the AT-8110/-8111 capable of cross- and intermodulation-free operation in communications LNA, radar preamplifier and EW amplifier applications.

The AT-8110/-8111, like all Avantek transistors, features a metal system that combines gold and refractory metals throughout, even the gate is gold metallized. This eliminates the corrosion, intermetallic growth (metal migration) and burn-out problems associated with some other metal systems used in GaAs FET fabrication — thus helping to assure excellent long-term reliability.

The AT-8110 version is packaged in the ultra-miniature 70 mil square metal-ceramic microstrip package. The package is filled with a dry, inert atmosphere and hermetically sealed to fully protect the GaAs FET chip from contamination, corrosive gasses and moisture. Each packaged transistor is leak tested before shipment to verify the true hermeticity of its package.

TYPICAL COMMON SOURCE OPERATING CHARACTERISTICS (T_A = 25°C)

PARAMETER	SYMBOL	VALUE	FREQUENCY	TEST CONDITION
Spot Noise Figure	NF _{opt}	1.3 dB (1.5 dB max)	4.0 GHz	V _{DS} = 3V, I _{DS} = 20 mA
		1.7 dB	6.0 GHz	V _{DS} = 3V, I _{DS} = 20 mA
Gain at Optimum Noise Figure	G _{NF}	12 dB (11 dB min)	4.0 GHz	V _{DS} = 3V, I _{DS} = 20 mA
		9 dB	6.0 GHz	V _{DS} = 3V, I _{DS} = 20 mA
Output Power at 1 dB Gain Compression *	P _{O(-1)}	+17 dBm	4.0 GHz	V _{DS} = 5V, I _{DS} = 50 mA

* Measured with a 50 ohm input source impedance and the output circuit tuned for maximum output power.

The AT-8111 is an unpackaged 15 x 19 mil chip suitable for MIC thin-film and thick-film hybrid circuits. It's gold metal system provides excellent bond strength and assures compatibility with the wire bonding techniques used in hybrid circuit fabrication. An optional PGA (polycrystalline gallium arsenide) protective layer is available on the AT-8111 chip to protect the surface

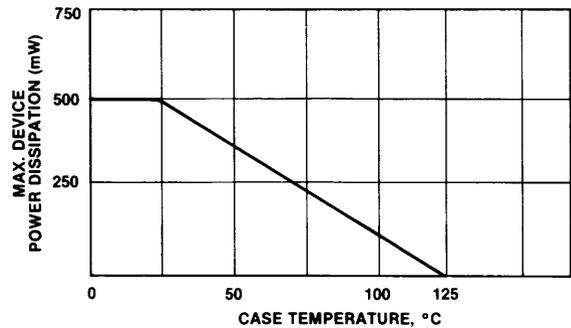
from damage or contamination during handling. The PGA layer is also opaque which prevents variations in operating parameters caused by light impingement during amplifier tuning.

Avantek transistors, including the AT-8110/8111, are 100% tested for both DC and RF parameters after packaging and leak testing.

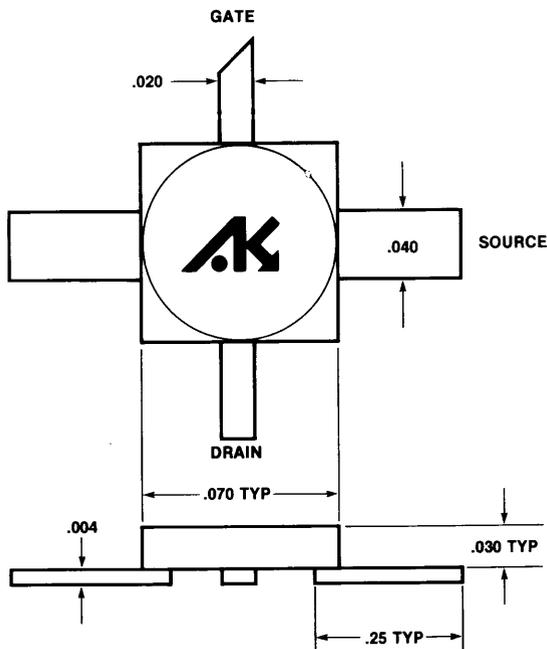
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Parameter	Symbol	Limit
Drain-Source Voltage	V_{DS}	+ 7V
Gate-Source Voltage	V_{GS}	- 5V
Drain Current	I_D	120 mA
Continuous Dissipation	P_T	500 mW
($T_{\text{case}} = 25^\circ\text{C}$)		
Channel Temperature	T_{ch}	125°C
Storage Temperature (AT-8110)	T_{stg}	- 65° to + 125°C
Thermal Resistance	θ_{CC}	200°C/W

POWER DERATING CURVE

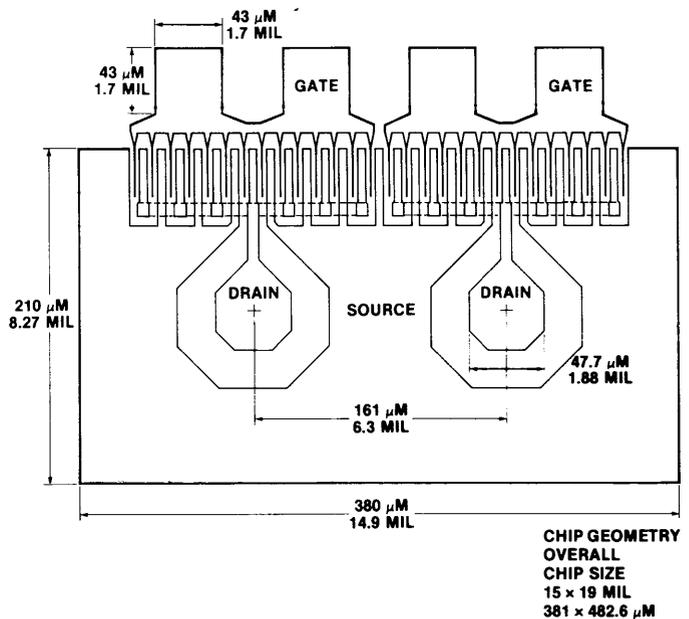


OUTLINE DRAWING: PACKAGED VERSION



TOLERANCES: $\pm .010 / \pm .02$
DIMENSIONS INCHES

OUTLINE DRAWING: UNPACKAGED CHIP

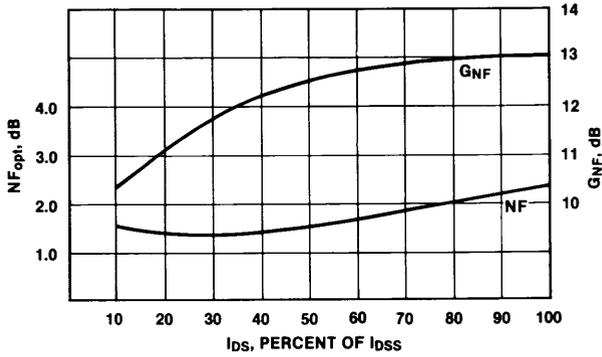


CHIP GEOMETRY
OVERALL
CHIP SIZE
15 x 19 MIL
381 x 482.6 μM

TYPICAL DC CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

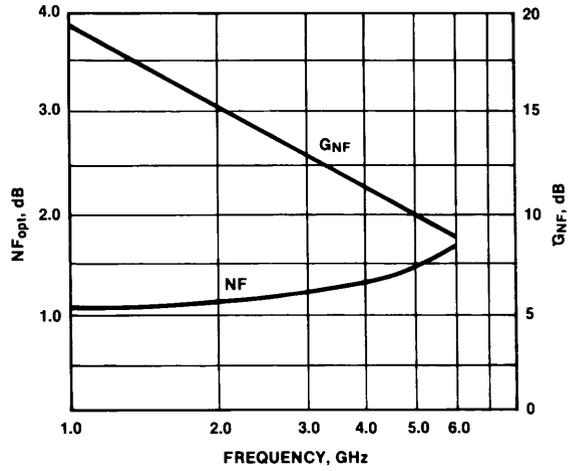
Parameter	Symbol	Value	Test Conditions
Transconductance	G_M	65 mmho (50 mmho min)	$V_{DS} = 3V, V_{GS} = 0V$
Saturated Drain Current	I_{DSS}	120 mA	$V_{DS} = 3V$
Pinchoff Voltage	V_P	- 2V	$V_{DS} = 3V, I_{DS} = 1 \text{ mA}$

SPOT NOISE FIGURE ($N_{F_{opt}}$) AND ASSOCIATED GAIN (G_{NF}) VS. I_{DS} AT $V_{DS} = 3V, f = 4\text{ GHz}$

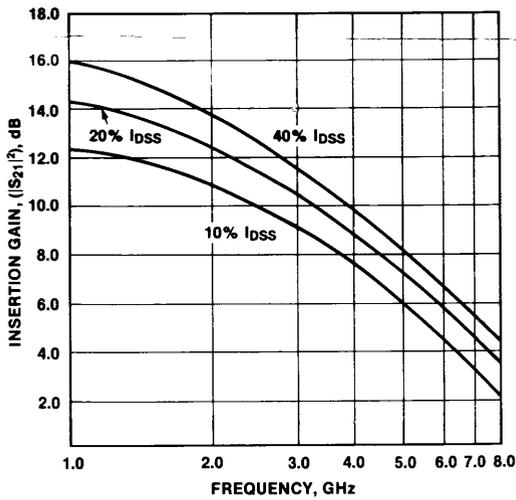


Note: Source admittance for the AT-8110 optimum noise figure at 4.0 GHz, $V_{DS} = 3V, I_{DS} = 20\text{ mA}$ is approximately (23-j24) mmho.

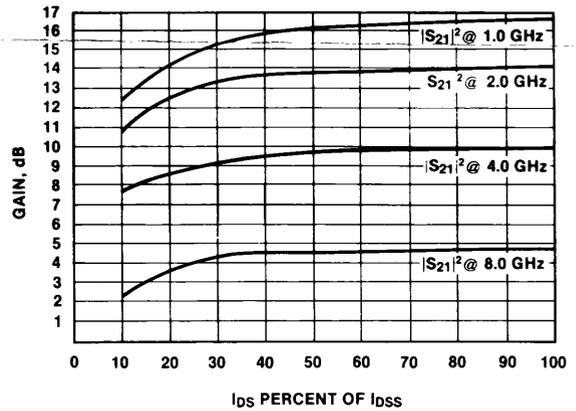
SPOT NOISE FIGURE ($N_{F_{opt}}$) AND ASSOCIATED GAIN (G_{NF}) VS. FREQUENCY $V_{DS} = 3V, I_{DS} = 20\text{ mA}$



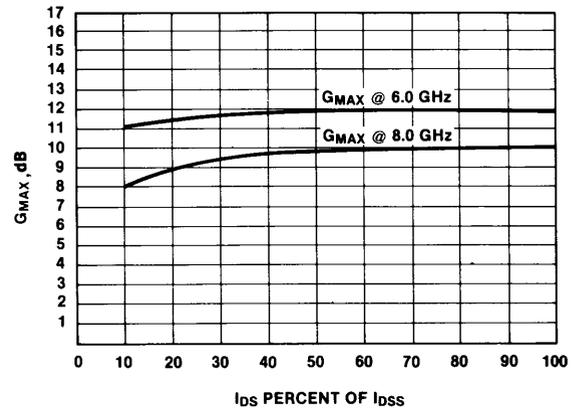
INSERTION POWER GAIN ($|S_{21}|^2$) VS FREQUENCY AND I_{DS} @ $V_{DS} = 3V$



INSERTION POWER GAIN ($|S_{21}|^2$) VS. I_{DS} $V_{DS} = 3V$



MAXIMUM AVAILABLE GAIN (G_{MAX}) VS. I_{DS} $V_{DS} = 3V$



Avantek

AT-8110/8111

BIAS= 3.00 VOLTS, 20.00 MA

S -- MAGN AND ANGLES:

FREQ	11	21	12	22
500.00	.924 -30.1	5.488 153.9	.031 60.1	.519 -23.8
1000.00	.877 -56.1	5.070 134.7	.052 48.0	.464 -40.2
1500.00	.834 -80.7	4.571 117.5	.069 36.3	.416 -56.7
2000.00	.797 -102.6	4.062 100.6	.080 24.7	.376 -71.3
2500.00	.774 -122.9	3.640 86.2	.087 14.5	.345 -85.8
3000.00	.758 -140.2	3.247 71.9	.092 5.6	.327 -99.3
3500.00	.737 -155.5	2.924 58.6	.095 -2.3	.307 -110.5
4000.00	.727 -168.4	2.663 47.2	.095 -8.9	.290 -120.6
4500.00	.721 178.9	2.417 35.8	.097 -14.7	.282 -132.3
5000.00	.713 167.1	2.229 24.5	.098 -19.5	.285 -144.7
5500.00	.712 156.4	2.059 14.4	.098 -23.7	.292 -156.4
6000.00	.712 147.1	1.897 5.2	.100 -28.8	.312 -167.7
6500.00	.709 138.8	1.772 -4.2	.101 -32.0	.335 -177.2
7000.00	.709 131.0	1.668 -13.5	.102 -36.3	.358 175.2
7500.00	.701 123.9	1.579 -22.2	.104 -39.9	.384 168.6
8000.00	.686 117.1	1.501 -31.0	.107 -43.5	.396 164.1

BIAS= 5.00 VOLTS, 50.00 MA

S -- MAGN AND ANGLES:

FREQ	11	21	12	22
500.00	.918 -33.2	6.827 151.9	.023 57.5	.575 -21.2
1000.00	.866 -61.5	6.197 131.6	.037 46.6	.515 -34.2
1500.00	.822 -87.7	5.481 113.8	.048 35.8	.465 -47.2
2000.00	.784 -110.3	4.779 96.7	.055 26.5	.425 -58.5
2500.00	.765 -130.7	4.224 82.0	.059 17.9	.395 -69.9
3000.00	.750 -147.7	3.720 68.2	.062 11.1	.377 -81.2
3500.00	.734 -162.9	3.329 54.9	.064 5.1	.365 -90.5
4000.00	.727 -175.3	3.022 43.5	.064 1.1	.346 -99.2
4500.00	.723 172.4	2.727 32.1	.066 -2.9	.337 -109.6
5000.00	.717 161.0	2.507 21.0	.068 -5.8	.337 -121.0
5500.00	.718 150.6	2.309 10.9	.070 -7.7	.341 -132.7
6000.00	.719 141.5	2.123 1.6	.072 -11.2	.356 -145.0
6500.00	.718 133.5	1.983 -7.8	.076 -13.7	.377 -155.8
7000.00	.717 125.7	1.855 -17.3	.079 -16.5	.403 -164.8
7500.00	.709 118.5	1.751 -26.3	.084 -19.8	.429 -173.4
8000.00	.695 111.7	1.659 -35.2	.089 -22.7	.451 -179.0